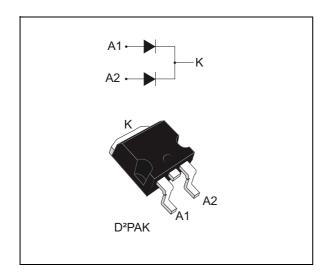


## STPS20H100C-Y

## Automotive power Schottky rectifier

Datasheet - production data



### **Description**

Dual center tap Schottky rectifier designed for high frequency miniature switched mode power supplies such as adaptators and on board DC/DC converters for automotive applications.

Table 1. Device summary

| Symbol               | Value    |
|----------------------|----------|
| I <sub>F(AV)</sub>   | 2 x 10 A |
| V <sub>RRM</sub>     | 100 V    |
| T <sub>j(max)</sub>  | 175 °C   |
| V <sub>F (Typ)</sub> | 0.59 V   |

#### **Features**

- Negligible switching losses
- · High junction temperature capability
- Good trade off between leakage current and forward voltage drop
- Low leakage current
- Avalanche rated
- · AEC-Q101 qualified.
- PPAP capable

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### 1 Characteristics

Table 2. Absolute ratings (limiting values per diode at 25 °C, unless otherwise specified)

| Symbol                          | Parameter   |  |            | Value       | Unit |
|---------------------------------|---|--|------------|-------------|------|
| V <sub>RRM</sub>                | Repetitive peak reverse voltage                                       |  |            | 100         | V    |
| I <sub>F(RMS)</sub>             | Forward rms current   |  |            | 30          | Α    |
| ı                               | Average forward current, $\delta$ = 0.5, $T_c$ = 160 °C               |  | per diode  | 10          | Α    |
| I <sub>F(AV)</sub>              | Average forward current, $0 = 0.5$ , $T_c = 100^{\circ}$ C            |  | per device | 20          | ^    |
| I <sub>FSM</sub>                | Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$ |  | oidal      | 250         | Α    |
| I <sub>RSM</sub>                | Non repetitive peak reverse current $t_p = 100 \mu s square$          |  | e          | 3           | Α    |
| P <sub>ARM</sub> <sup>(1)</sup> | Repetitive peak avalanche power $t_p = 10 \mu s, T_j = 125 °C$        |  |            | 780         | W    |
| T <sub>stg</sub>                | Storage temperature range   |  |            | -65 to +175 | °C   |
| Tj                              | Operating junction temperature <sup>(2)</sup>                         |  |            | -40 to +175 | °C   |

<sup>1.</sup> For pulse time duration deratings, please refer to *Figure 3*. More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the STMicroelectronics Application notes AN1768, "Admissible avalanche power of Schottky diodes" and AN2025, "Converter improvement using Schottky rectifier avalanche specification".

**Table 3. Thermal parameters** 

| Symbol               | Parameter        | Value    | Unit |      |
|----------------------|------------------|----------|------|------|
| D                    | Junction to case | er diode | 1.6  |      |
| R <sub>th(j-c)</sub> | per device       |          | 0.9  | °C/W |
| R <sub>th(c)</sub>   | coupling         |          | 0.15 |      |

When the diodes 1 and 2 are used simultaneously:  $\Delta Tj(diode 1) = P(diode1) \times R_{th(j-c)}(Per diode) + P(diode 2) \times R_{th(c)}(Per diode) + P(diode 2) \times R_{th(c)}(Per diode) + P(diode 3) \times R_{th(c)}(Per diode$ 

Table 4. Static electrical characteristics (per diode)

| Symbol                            | Parameter               | Test conditions         |                                   | Min. | Тур  | Max. | Unit |
|-----------------------------------|-------------------------|-------------------------|-----------------------------------|------|------|------|------|
| I <sub>R</sub> <sup>(1)</sup> Rev | Reverse leakage current | T <sub>j</sub> = 25 °C  | V <sub>R</sub> = V <sub>RRM</sub> | -    | -    | 4.5  | μΑ   |
| 'R`´                              | Reverse leakage current | T <sub>j</sub> = 125 °C |                                   | -    | 2    | 6    | mA   |
|                                   |                         | T <sub>j</sub> = 25 °C  | I <sub>F</sub> = 10 A             | -    | -    | 0.77 | V    |
| V <sub>E</sub> <sup>(2)</sup>     | Forward voltage drop    | T <sub>j</sub> = 125 °C |                                   | -    | 0.59 | 0.64 |      |
| VEV Forward volta                 | Forward voltage drop    | T <sub>j</sub> = 25 °C  | I <sub>F</sub> = 20 A             | -    | -    | 0.88 | V    |
|                                   |                         | T <sub>j</sub> = 125 °C | 1F = 20 A                         | -    | 0.67 | 0.73 |      |

<sup>1.</sup> Pulse test:  $t_p = 5$  ms,  $\delta < 2\%$ 

<sup>2.</sup>  $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

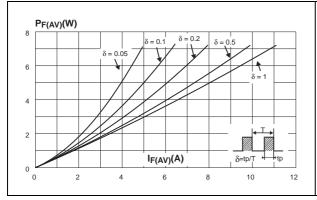
<sup>2.</sup> Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2%

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To evaluate the conduction losses use the following equation:  $P = 0.55 \times I_{F(AV)} + 0.009 \times I_{F}^{2}_{(RMS)}$ 

Figure 1. Average forward power dissipation versus average forward current (per diode)

Figure 2. Average forward current versus ambient temperature ( $\delta$  = 0.5, per diode)



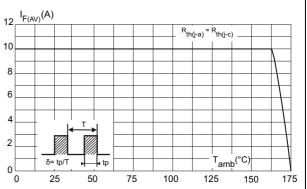
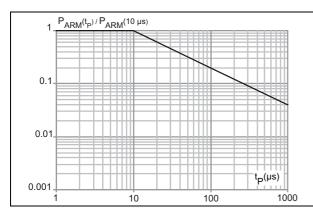


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Relative variation of thermal impedance junction to case versus pulse duration (per diode)



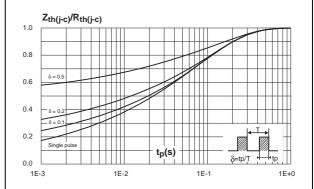
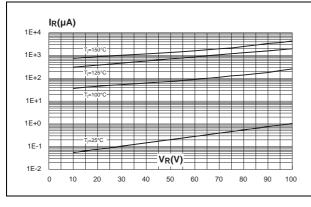
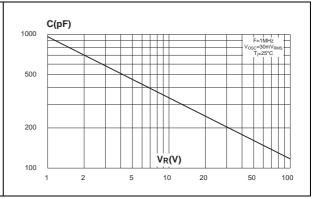


Figure 5. Reverse leakage current versus reverse voltage applied (typical values, per diode)

Figure 6. Junction capacitance vs. reverse voltage applied (typical values, per diode)





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Figure 7. Forward voltage drop vs. forward current (typical values, per diode)

10.0

10.0

10.0

T<sub>j=150°C</sub> (ypical values)

1.0

T<sub>j=25°C</sub>
T<sub>j=25°C</sub>
T<sub>j=25°C</sub>

T<sub>j=25°C</sub>

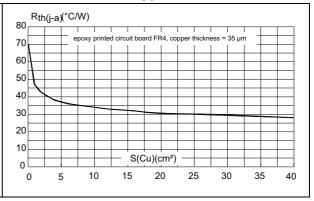
0.6

0.8

1.0

0.4

Figure 8. Thermal resistance junction to ambient versus copper surface under tab



## 2 Package information

- Epoxy meets UL94, V0
- Lead-free package
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

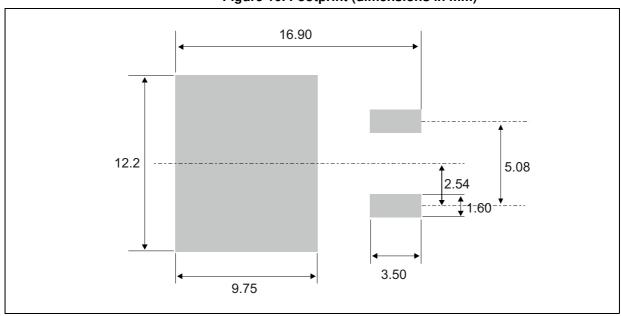
Figure 9. D<sup>2</sup>PAK dimension definitions Α C2 Ε L2 D R B2 В A2 G V2 \* Flat zone no less than 2 mm

Package information STPS20H100C-Y

Table 5. D<sup>2</sup>PAK dimension values

|      | Dimensions  |           |       |            |      |       |
|------|-------------|-----------|-------|------------|------|-------|
| Ref. | Millimeters |           |       | Inches     |      |       |
|      | Min.        | Тур.      | Max.  | Min.       | Тур. | Max.  |
| Α    | 4.40        |           | 4.60  | 0.173      |      | 0.181 |
| A1   | 2.49        |           | 2.69  | 0.098      |      | 0.106 |
| A2   | 0.03        |           | 0.23  | 0.001      |      | 0.009 |
| В    | 0.70        |           | 0.93  | 0.027      |      | 0.037 |
| B2   | 1.14        |           | 1.70  | 0.045      |      | 0.067 |
| С    | 0.45        |           | 0.60  | 0.017      |      | 0.024 |
| C2   | 1.23        |           | 1.36  | 0.048      |      | 0.054 |
| D    | 8.95        |           | 9.35  | 0.352      |      | 0.368 |
| E    | 10.00       |           | 10.40 | 0.393      |      | 0.409 |
| G    | 4.88        |           | 5.28  | 0.192      |      | 0.208 |
| L    | 15.00       |           | 15.85 | 0.590      |      | 0.624 |
| L2   | 1.27        |           | 1.40  | 0.050      |      | 0.055 |
| L3   | 1.30        |           | 1.75  | 0.051      |      | 0.069 |
| М    | 2.29        |           | 2.79  | 0.090      |      | 0.110 |
| R    |             | 0.40 typ. |       | 0.016 typ. |      |       |
| V2   | 0°          |           | 8°    | 0°         |      | 8°    |

Figure 10. Footprint (dimensions in mm)



# 3 Ordering information

**Table 6. Ordering information** 

| Order code       | Marking       | Package            | Weight | Base qty | Delivery mode |  |
|------------------|---------------|--------------------|--------|----------|---------------|--|
| STPS20H100CGY-TR | STPS20H100CGY | D <sup>2</sup> PAK | 1.48 g | 1000     | Tape and reel |  |

# 4 Revision history

Table 7. Revision history

| Date        | Revision | Changes     |
|-------------|----------|-------------|
| 19-Nov-2014 | 1        | First issue |

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